

PATENT APPLICATION
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q88153

Koji WATANABE, et al

Appln. No.: National Stage of PCT/JP03/16906

Confirmation No.: Unknown

Group Art Unit: Unknown

Filed: July 07, 2005

Examiner: Unknown

For: CURING RESIN COMPOSITION, ADHESIVE EPOXY RESIN PASTE, ADHESIVE
EPOXY RESIN SHEET, CONDUCTIVE CONNECTION PASTE, CONDUCTIVE
CONNECTION SHEET, AND ELECTRONIC COMPONENT JOINED BODY

PRELIMINARY AMENDMENT

MAIL STOP AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Prior to examination, please amend the above-identified application as follows on the
accompanying pages.

TABLE OF CONTENTS

AMENDMENTS TO THE CLAIMS	2
REMARKS	11